Log-taper, 100-tap Digital Potentiometer (POT)

Description

The CAT5116 is a log-taper single digital POT designed as an electronic replacement for mechanical potentiometers.

Ideal for automated adjustments on high volume production lines, ICs are well suited for applications where equipment requiring periodic adjustment is either difficult to access or located in a hazardous or remote environment.

The CAT5116 contains a 100-tap series resistor array connected between two terminals $R_{\rm H}$ and $R_{\rm L}$. An up/down counter and decoder that are controlled by three input pins, determines which tap is connected to the wiper, $R_{\rm W}$.

The wiper setting, stored in nonvolatile memory, is not lost when the device is powered down and is automatically reinstated when power is returned. The wiper can be adjusted to test new system values without effecting the stored setting.

Wiper-control of the CAT5116 is accomplished with three input control pins, \overline{CS} , U/ \overline{D} , and \overline{INC} . The \overline{INC} input increments the wiper in the direction which is determined by the logic state of the U/ \overline{D} input. The \overline{CS} input is used to select the device and also store the wiper position prior to power down.

The digital POT can be used as a three-terminal resistive divider or as a two-terminal variable resistor.

Features

- 100-position, Log-taper Potentiometer
- Non-volatile EEPROM Wiper Storage
- 10 nA Ultra-low Standby Current
- Single-supply Operation: 2.5 V 5.5 V
- Increment Up/Down Serial Interface
- Resistance Value: 32 kΩ
- Available in 8-pin MSOP, TSSOP, SOIC and DIP Packages
- These Devices are Pb-Free, Halogen Free/BFR Free and are RoHS Compliant

Applications

- Automated Product Calibration
- Remote Control Adjustments
- Offset, Gain and Zero Control
- Audio Volume Control
- Sensor Adjustment
- · Motor Controls and Feedback Systems
- Programmable Analog Functions



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MSOP-8 Z SUFFIX CASE 846AD

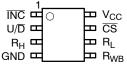


PDIP-8 L SUFFIX CASE 646AA

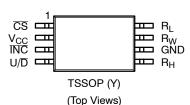


TSSOP-8 Y SUFFIX CASE 948AL

PIN CONFIGURATIONS



PDIP (L), SOIC (V), MSOP (Z)



PIN FUNCTION

Pin Name	Function		
ĪNC	Increment Control		
U/D	Up/Down Control		
R _H	Potentiometer High Terminal		
GND	Ground		
R_W	Buffered Wiper Terminal		
R_{L}	Potentiometer Low Terminal		
CS	Chip Select		
V _{CC}	Supply Voltage		

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

Functional Diagram

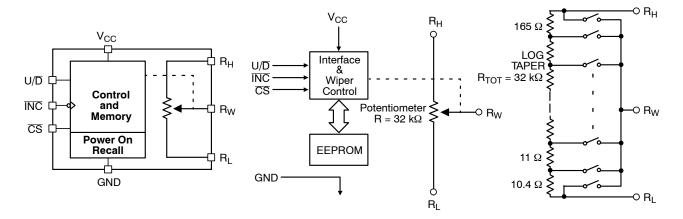


Figure 1. General

Figure 2. Block Diagram

Figure 3. Potentiometer Schematic

Pin Description

INC: Increment Control Input

The \overline{INC} input moves the wiper in the up or down direction determined by the condition of the U/ \overline{D} input.

U/D: Up/Down Control Input

The U/\overline{D} input controls the direction of the wiper movement. When in a high state and \overline{CS} is low, any high-to-low transition on \overline{INC} will cause the wiper to move one increment toward the R_H terminal. When in a low state and \overline{CS} is low, any high-to-low transition on \overline{INC} will cause the wiper to move one increment towards the R_L terminal.

RH: High End Potentiometer Terminal

 $R_{\rm H}$ is the high end terminal of the potentiometer. It is not required that this terminal be connected to a potential greater than the $R_{\rm L}$ terminal. Voltage applied to the $R_{\rm H}$ terminal cannot exceed the supply voltage, $V_{\rm CC}$ or go below ground, GND.

Rw: Wiper Potentiometer Terminal

 R_W is the wiper terminal of the potentiometer. Its position on the resistor array is controlled by the control inputs, \overline{INC} , U/\overline{D} and \overline{CS} . Voltage applied to the R_W terminal cannot exceed the supply voltage, V_{CC} or go below ground, GND.

R_L: Low End Potentiometer Terminal

 $R_{\rm L}$ is the low end terminal of the potentiometer. It is not required that this terminal be connected to a potential less than the $R_{\rm H}$ terminal. Voltage applied to the $R_{\rm L}$ terminal cannot exceed the supply voltage, $V_{\rm CC}$ or go below ground, GND. $R_{\rm L}$ and $R_{\rm H}$ are electrically interchangeable.

CS: Chip Select

The chip select input is used to activate the control input of the CAT5116 and is active low. When in a high state, activity on the $\overline{\rm INC}$ and $\rm U/\overline{\rm D}$ inputs will not affect or change the position of the wiper.

Device Operation

The CAT5116 operates like a digitally controlled potentiometer with R_H and R_L equivalent to the high and low terminals and R_W equivalent to the mechanical potentiometer's wiper. There are 100 tap positions including the resistor end points, R_H and R_L . There are 99 resistor elements connected in series between the R_H and R_L terminals. The wiper terminal is connected to one of the 100 taps and controlled by three inputs, $\overline{\rm INC}$, U/D and $\overline{\rm CS}$. These inputs control a seven-bit up/down counter whose output is decoded to select the wiper position. The selected wiper position can be stored in nonvolatile memory using the $\overline{\rm INC}$ and $\overline{\rm CS}$ inputs.

With $\overline{\text{CS}}$ set LOW the CAT5116 is selected and will respond to the U/ $\overline{\text{D}}$ and $\overline{\text{INC}}$ inputs. HIGH to LOW transitions on $\overline{\text{INC}}$ will increment or decrement the wiper (depending on the state of the U/ $\overline{\text{D}}$ input and seven-bit counter). The wiper, when at either fixed terminal, acts like its mechanical equivalent and does not move beyond the last position. The value of the counter is stored in nonvolatile memory whenever $\overline{\text{CS}}$ transitions HIGH while the $\overline{\text{INC}}$ input is also HIGH. When the CAT5116 is powered-down, the last stored wiper counter position is maintained in the nonvolatile memory. When power is restored, the contents of the memory are recalled and the counter is set to the value stored.

With INC set low, the CAT5116 may be deselected and powered down without storing the current wiper position in nonvolatile memory. This allows the system to always power up to a preset value stored in nonvolatile memory.

Table 1. OPERATION MODES

INC	CS	U/D	Operation
High to Low	Low	High	Wiper toward H
High to Low	Low	Low	Wiper toward L
High	Low to High	Х	Store Wiper Position
Low	Low to High	Х	No Store, Return to Standby
Х	High	Х	Standby

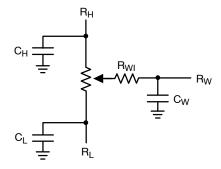


Figure 4. Potentiometer Equivalent Circuit

Table 2. ABSOLUTE MAXIMUM RATINGS

Parameters	Ratings	Units
Supply Voltage V _{CC} to GND	-0.5 to +7	V
Inputs CS to GND	-0.5 to V _{CC} +0.5	V
INC to GND	-0.5 to V _{CC} +0.5	V
U/D to GND	-0.5 to V _{CC} +0.5	V
R _H to GND	-0.5 to V _{CC} +0.5	V
R _L to GND	-0.5 to V _{CC} +0.5	V
R _W to GND	-0.5 to V _{CC} +0.5	V
Operating Ambient Temperature Industrial ('1' suffix)	-40 to +85	°C
Junction Temperature (10 s)	+150	°C
Storage Temperature	+150	°C
Lead Soldering (10 s max)	+300	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Table 3. RELIABILITY CHARACTERISTICS

Symbol	Parameter	Test Method	Min	Тур	Max	Units
V _{ZAP} (Note 1)	ESD Susceptibility	MIL-STD-883, Test Method 3015	2000			V
I _{LTH} (Notes 1, 2)	Latch-up	JEDEC Standard 17	100			mA
T _{DR}	Data Retention	MIL-STD-883, Test Method 1008	100			Years
N _{END}	Endurance	MIL-STD-883, Test Method 1003	1,000,000			Stores

This parameter is tested initially and after a design or process change that affects the parameter.
 Latch-up protection is provided for stresses up to 100 mA on address and data pins from -1 V to V_{CC} + 1 V.

Table 4. DC ELECTRICAL CHARACTERISTICS (V_{CC} = +2.5 V to +5.5 V unless otherwise specified)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
POWER SUPPL	Y		•			<u></u>
V _{CC}	Operating Voltage Range		2.5	-	5.5	V
I _{CC1} (Note 5)	Supply Current (Increment)	$V_{CC} = 5.5 \text{ V}, f = 1 \text{ MHz}, I_W = 0$	_	-	100	μΑ
		$V_{CC} = 5.5 \text{ V}, f = 250 \text{ kHz}, I_W = 0$	_	-	50	μΑ
I _{CC2}	Supply Current (Write)	Programming, V _{CC} = 5.5 V	-	-	1	mA
		V _{CC} = 3 V	-	-	500	μΑ
I _{SB1}	Supply Current (Standby)	$\overline{\text{CS}} = \text{V}_{\text{CC}} - 0.3 \text{ V}$ U/ $\overline{\text{D}}$, $\overline{\text{INC}} = \text{V}_{\text{CC}} - 0.3 \text{ V}$ or GND	-	0.01	1	μΑ
LOGIC INPUTS						
I _{IH}	Input Leakage Current	V _{IN} = V _{CC}	_	-	10	μΑ
I _{IL}	Input Leakage Current	V _{IN} = 0 V	_	-	-10	μΑ
V _{IH1}	TTL High Level Input Voltage	4.5 V ≤ V _{CC} ≤ 5.5 V	2	-	V _{CC}	V
V _{IL1}	TTL Low Level Input Voltage		0	-	0.8	V
V _{IH2}	CMOS High Level Input Voltage	2.5 V ≤ V _{CC} ≤ 5.5 V	V _{CC} x 0.7	-	V _{CC} + 0.3	V
V_{IL2}	CMOS Low Level Input Voltage		-0.3	-	V _{CC} x 0.2	V
POTENTIOMET	ER PARAMETERS					
R _{POT}	Potentiometer Resistance			32		kΩ
R _{TOL}	Pot. Resistance Tolerance				±20	%
V_{RH}	Voltage on R _H pin		0		V _{CC}	V
V_{RL}	Voltage on R _L pin		0		V _{CC}	V
R _V (Note 6)	Relative Variation				0.05	
R _{WI}	Wiper Resistance	V _{CC} = 5 V, I _W = 1 mA		200	400	Ω
		V _{CC} = 2.5 V, I _W = 1 mA		400	1000	Ω
I _W	Wiper Current				1	mA
TC _{RPOT}	TC of Pot Resistance			300		ppm/°0
TC _{RATIO}	Ratiometric TC				20	ppm/°0
V _N	Noise	100 kHz / 1 kHz		8/24		nV/√H
C _H /C _L /C _W	Potentiometer Capacitances			8/8/25		pF
fc	Frequency Response	Passive Attenuator, 10 kΩ		1.7		MHz

Latch-up protection is provided for stresses up to 100 mA on address and data pins from -1 V to V_{CC} + 1 V.
 This parameter is tested initially and after a design or process change that affects the parameter.
 I_W = source or sink.
 Relative variation is a measure of the error in step size between taps = log (V_{W(N)}) - log(V_{W(N-1)}) = 0.045 ± 0.003.

Table 5. AC TEST CONDITIONS

V _{CC} Range	$2.5 \text{ V} \le \text{V}_{CC} \le 5.5 \text{ V}$	
Input Pulse Levels	0.2 V_{CC} to 0.7 V_{CC}	
Input Rise and Fall Times	10 ns	
Input Reference Levels	0.5 V _{CC}	

Table 6. AC OPERATING CHARACTERISTICS (V_{CC} = +2.5 V to +5.5 V, V_H = V_{CC} , V_L = 0 V, unless otherwise specified)

Symbol	Parameter	Min	Typ (Note 7)	Max	Units	
t _{Cl}	CS to INC Setup	100	-	-	ns	
t _{DI}	U/D to INC Setup	50	-	-	ns	
t _{ID}	U/D to INC Hold	100	-	=	ns	
t _{IL}	ĪNC LOW Period	250	-	-	ns	
t _{IH}	TNC HIGH Period	250	-	-	ns	
t _{IC}	INC Inactive to CS Inactive	1	-	-	μs	
t _{CPH1}	CS Deselect Time (NO STORE)	100	-	=	ns	
t _{CPH2}	CS Deselect Time (STORE)	10	-	=	ms	
t _{IW}	ĪNC to V _{OUT} Change	-	1	5	μs	
tcyc	ĪNC Cycle Time	1	-	=	μs	
t _R , t _F (Note 8)	INC Input Rise and Fall Time	-	-	500	μs	
t _{PU} (Note 8)	Power-up to Wiper Stable	-	-	1	ms	
t _{WR}	Store Cycle	-	5	10	ms	

- 7. Typical values are for T_A = 25°C and nominal supply voltage.
 8. This parameter is periodically sampled and not 100% tested.
- 9. MI in the A.C. Timing diagram refers to the minimum incremental change in the W output due to a change in the wiper position.

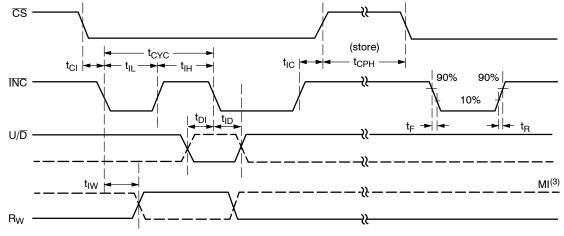
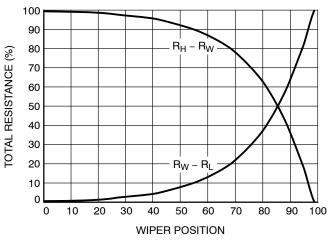


Figure 5. A.C. Timing

TYPICAL CHARACTERISTICS

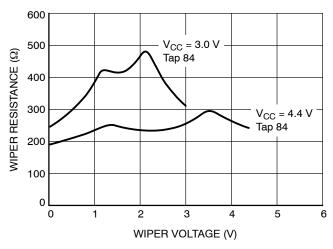
(V_{CC} = 5 V, T_{AMB} = 25°C, unless otherwise specified)



100 (%) 100 100 0.1 0 10 20 30 40 50 60 70 80 90 100 WIPER POSITION

Figure 6. Wiper-Low/High Resistances vs. Wiper Position

Figure 7. Wiper-Low Resistance vs. Wiper Position (Log Scale)



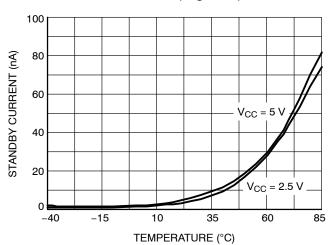


Figure 8. Wiper Resistance vs. Wiper Voltage

Figure 9. Standby Supply Current vs. Temperature

Table 7. ORDERING INFORMATION

Device	Package	Shipping [†]
CAT5116LI-G	PDIP-8 (Pb-Free)	50 Units / Rail
CAT5116VI-G	SOIC-8 (Pb-Free)	100 Units / Rail
CAT5116VI-GT3	SOIC-8 (Pb-Free)	3000 / Tape & Reel
CAT5116YI-G	TSSOP-8 (Pb-Free)	100 Units / Rail
CAT5116YI-GT3	TSSOP-8 (Pb-Free)	3000 / Tape & Reel
CAT5116ZI	MSOP-8 (Pb-Free)	96 Units / Rail
CAT5116ZI-T3	MSOP-8 (Pb-Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{10.} For detailed information and a breakdown of device nomenclature and numbering systems, please see the ON Semiconductor Device Nomenclature document, TND310/D, available at www.onsemi.com.

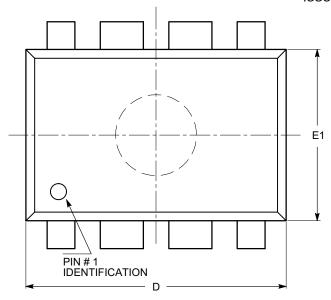
^{11.} All packages are RoHS-compliant (Lead-free, Halogen-free).

^{12.} The standard lead finish is NiPdAu.

^{13.} Contact factory for Matte-Tin finish.

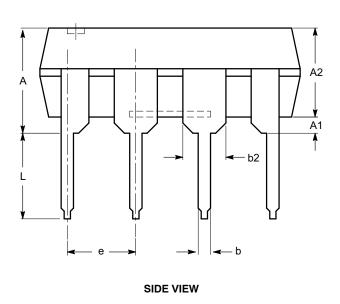
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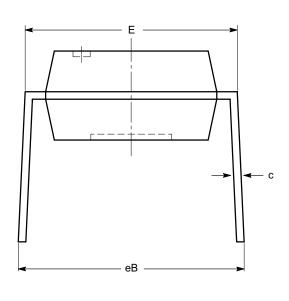
PDIP-8, 300 mils CASE 646AA ISSUE A



SYMBOL	MIN	NOM	MAX	
Α			5.33	
A1	0.38			
A2	2.92	3.30	4.95	
b	0.36	0.46	0.56	
b2	1.14	1.52	1.78	
С	0.20	0.25	0.36	
D	9.02	9.27	10.16	
Е	7.62	7.87	8.25	
E1	6.10	6.35	7.11	
е	2.54 BSC			
eB	7.87		10.92	
L	2.92	3.30	3.80	

TOP VIEW





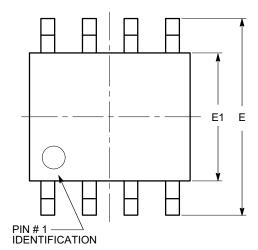
END VIEW

Notes:

- (1) All dimensions are in millimeters.
- (2) Complies with JEDEC MS-001.

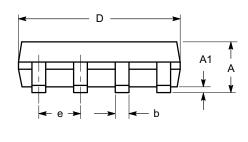
PACKAGE DIMENSIONS

SOIC 8, 150 mils CASE 751BD ISSUE O

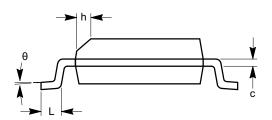


SYMBOL	MIN	NOM	MAX
Α	1.35		1.75
A1	0.10		0.25
b	0.33		0.51
С	0.19		0.25
D	4.80		5.00
E	5.80		6.20
E1	3.80		4.00
е		1.27 BSC	
h	0.25		0.50
L	0.40		1.27
θ	0°		8°

TOP VIEW



SIDE VIEW



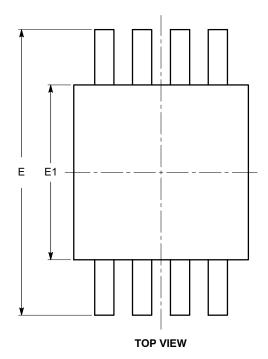
END VIEW

Notes:

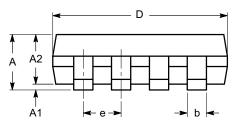
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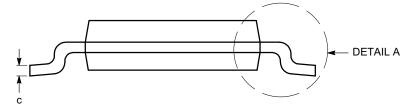
PACKAGE DIMENSIONS

MSOP 8, 3x3 CASE 846AD ISSUE O



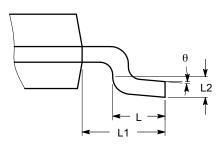
SYMBOL	MIN	NOM	MAX
Α			1.10
A1	0.05	0.10	0.15
A2	0.75	0.85	0.95
b	0.22		0.38
С	0.13		0.23
D	2.90	3.00	3.10
E	4.80	4.90	5.00
E1	2.90	3.00	3.10
е		0.65 BSC	
L	0.40	0.60	0.80
L1	0.95 REF		
L2	0.25 BSC		
θ	0°		6°





SIDE VIEW

END VIEW



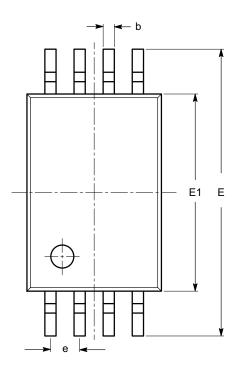
Notes:

- (1) All dimensions are in millimeters. Angles in degrees.(2) Complies with JEDEC MO-187.

DETAIL A

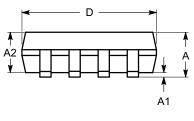
PACKAGE DIMENSIONS

TSSOP8, 4.4x3 CASE 948AL **ISSUE 0**

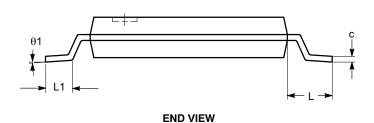


SYMBOL	MIN	NOM	MAX	
Α			1.20	
A1	0.05		0.15	
A2	0.80	0.90	1.05	
b	0.19		0.30	
С	0.09		0.20	
D	2.90	3.00	3.10	
Е	6.30	6.40	6.50	
E1	4.30	4.40	4.50	
е		0.65 BSC		
L	1.00 REF			
L1	0.50	0.60	0.75	
θ	0°		8°	









Notes:

- (1) All dimensions are in millimeters. Angles in degrees.
- (2) Complies with JEDEC MO-153.

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